- **Operation from Very Slow Edges**
- **Improved Line-Receiving Characteristics**
- **High Noise Immunity**

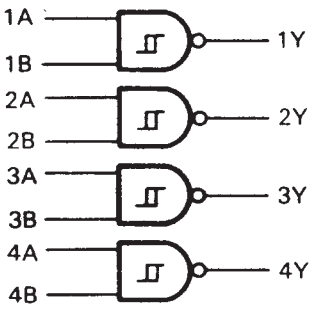
description

Each circuit functions as a 2-input NAND gate, but because of the Schmitt action, it has different input threshold levels for positive (V_{T+}) and for negative going (V_{T-}) signals.

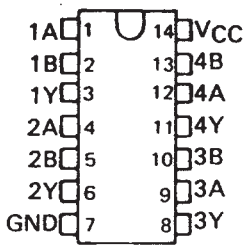
These circuits are temperature-compensated and can be triggered from the slowest of input ramps and still give clear, jitter-free output signals.

The SN54132, SN54LS132, and SN54S132 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN74132, SN74LS132, and SN74S132 are characterized for operation from 0°C to 70°C.

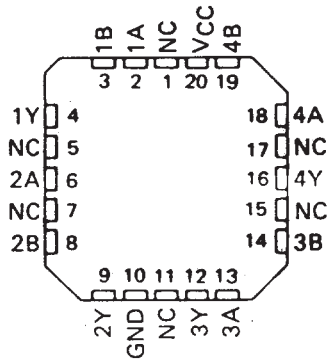
logic diagram (positive logic)



SN54132, SN54LS132, SN54S132 . . . J OR W PACKAGE
SN74132 . . . N PACKAGE
SN74LS132, SN74S132 . . . D OR N PACKAGE
(TOP VIEW)

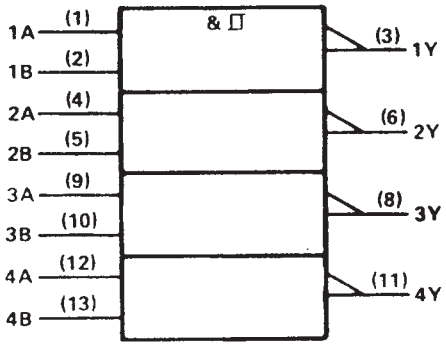


SN54LS132, SN54S132 . . . FK PACKAGE
(TOP VIEW)



NC-No internal connection

logic symbol†

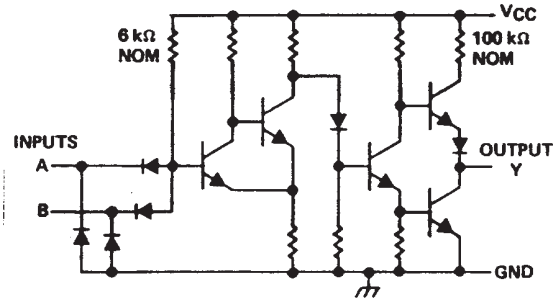


positive logic: $Y = \overline{AB}$ or $Y = \overline{A} + \overline{B}$

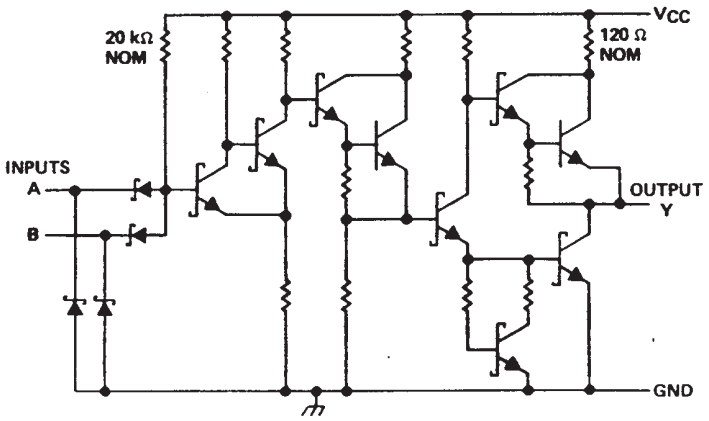
†This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

schematics

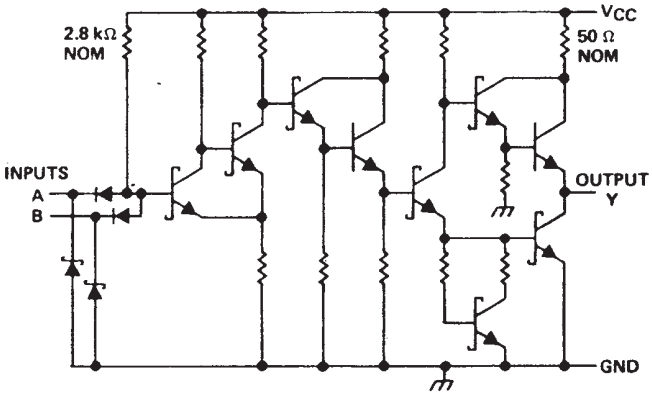
'132 CIRCUITS



'LS132 CIRCUITS



'S132 CIRCUITS



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: '132, 'S132 . . . . . 5.5 V
'LS132 . . . . . 7 V
Operating free-air temperature: SN54' . . . . . −55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltages values are with respect to network ground terminal.

recommended operating conditions

		SN54132			SN74132			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current			– 0.8			– 0.8	mA
I_{OL}	Low-level output current			16			16	mA
T_A	Operating free-air temperature	– 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†			MIN	TYP‡	MAX	UNIT
V_{T+}	V_{CC} = 5 V			1.5	1.7	2	V
V_{T-}	V_{CC} = 5 V			0.6	0.9	1.1	V
V_{hys} ($V_{T+} - V_{T-}$)	V_{CC} = 5 V			0.4	0.8		V
V_{IK}	V_{CC} = MIN,	I_I = – 12 mA				– 1.5	V
V_{OH}	V_{CC} = MIN,	V_I = 0.6 V,	I_{OH} = – 0.8 mA	2.4	3.4		V
V_{OL}	V_{CC} = MIN,	V_I = 2 V,	I_{OL} = 16 mA		0.2	0.4	V
I_{T+}	V_{CC} = 5 V,	$V_I = V_{T+}$			– 0.43		mA
I_{T-}	V_{CC} = 5 V,	$V_I = V_{T-}$			– 0.56		mA
I_I	V_{CC} = MAX,	V_I = 5.5 V				1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.4 V				40	μA
I_{IL}	V_{CC} = MAX,	V_{IL} = 0.4 V			– 0.8	– 1.2	mA
I_{OS}§	V_{CC} = MAX			– 18		– 55	mA
I_{CCH}	V_{CC} = MAX				15	24	mA
I_{CCL}	V_{CC} = MAX				26	40	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Any	Y	R_L = 400 Ω, C_L = 15 pF		15	22	ns
t_{PHL}					15	22	ns

recommended operating conditions

	SN54LS132			SN74LS132			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
I_{OH} High-level output current			−0.4			−0.4	mA
I_{OL} Low-level output current			4			8	mA
T_A Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54LS132			SN74LS132			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{T+}	V_{CC} = 5 V		1.4	1.6	1.9	1.4	1.6	1.9	V
V_{T-}	V_{CC} = 5 V		0.5	0.8	1	0.5	0.8	1	V
V_{hys} ($V_{T+} - V_{T-}$)	V_{CC} = 5 V		0.4	0.8		0.4	0.8		V
V_{IK}	V_{CC} = MIN, I_I = −18 mA				−1.5			−1.5	V
V_{OH}	V_{CC} = MIN, V_I = 0.5 V,	I_{OH} = −0.4 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN, V_I = 1.9 V	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 8 mA					0.35	0.5	
I_{T+}	V_{CC} = 5 V, V_I = V_{T+}			−0.14			−0.14		mA
I_{T-}	V_{CC} = 5 V, V_I = V_{T-}			−0.18			−0.18		mA
I_I	V_{CC} = MAX, V_I = 7 V				0.1			0.1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.7 V				20			20	μA
I_{IL}	V_{CC} = MAX, V_{IL} = 0.4 V				−0.4			−0.4	mA
I_{OS} §	V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CCH}	V_{CC} = MAX			5.9	11		5.9	11	mA
I_{CCL}	V_{CC} = MAX			8.2	14		8.2	14	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Any	Y	R_L = 2 kΩ, C_L = 15 pF		15	22	ns
t_{PHL}					15	22	ns

recommended operating conditions

		SN54S132			SN74S132			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current			−1			−1	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

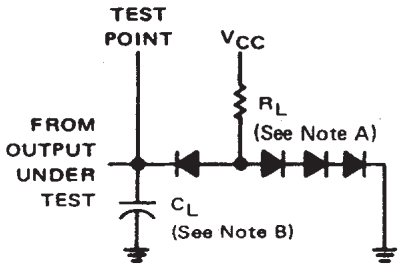
PARAMETER	TEST CONDITIONS†			SN54S132			SN74S132			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{T+}	V_{CC} = 5 V			1.6	1.77	1.9	1.6	1.77	1.9	V
V_{T-}	V_{CC} = 5 V			1.1	1.22	1.4	1.1	1.22	1.4	V
V_{hys} ($V_{T+} - V_{T-}$)	V_{CC} = 5 V			0.2	0.55		0.2	0.55		V
V_{IK}	V_{CC} = MIN,	I_I = −18 mA				−1.2			−1.2	V
V_{OH}	V_{CC} = MIN,	V_I = 1.1 V,	I_{OH} = −1 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN,	V_I = 1.9 V,	I_{OL} = 20 mA			0.5			0.5	V
I_{T+}	V_{CC} = 5 V,	$V_I = V_{T+}$			−0.9			−0.9		mA
I_{T-}	V_{CC} = 5 V,	$V_I = V_{T-}$			−1.1			−1.1		mA
I_I	V_{CC} = MAX,	V_I = 5.5 V				1			1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.7 V				50			50	μA
I_{IL}	V_{CC} = MAX,	V_{IL} = 0.5 V				−2			−2	mA
I_{OS}§	V_{CC} = MAX			−40		−100	−40		−100	mA
I_{CCH}	V_{CC} = MAX				28	44		28	44	mA
I_{CCL}	V_{CC} = MAX				44	68		44	68	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

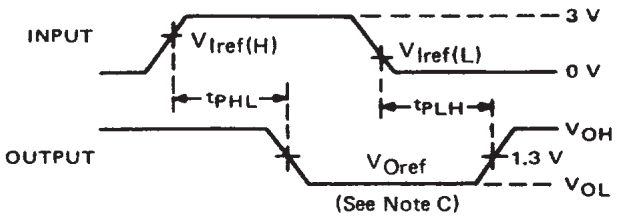
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 280 Ω,	C_L = 15 pF		7	10.5	ns
t_{PHL}						8.5	13	ns

PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT



VOLTAGE WAVEFORMS

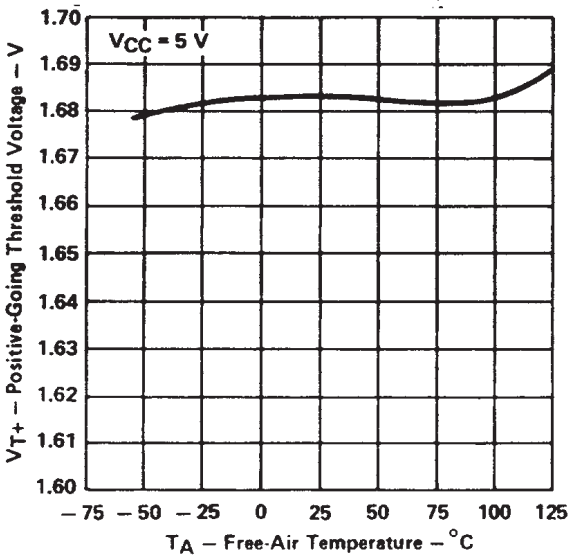
NOTES: A. All diodes are 1N3064 or equivalent.
B. C_L includes probe and jig capacitance.
C. Generator characteristics and reference voltages are:

	Generator Characteristics				Reference Voltages		
	Z_{out}	PRR	t_r	t_f	$V_{I\ ref(H)}$	$V_{I\ ref(L)}$	$V_{O\ ref}$
SN54'/SN74'	50	1 MHz	10 ns	10 ns	1.7 V	0.9 V	1.5 V
SN54LS'/SN74LS'	50	1 MHz	15 ns	6 ns	1.6 V	0.8 V	1.3 V
'S132	50	1 MHz	2.5 ns	2.5 ns	1.8 V	1.2 V	1.5 V

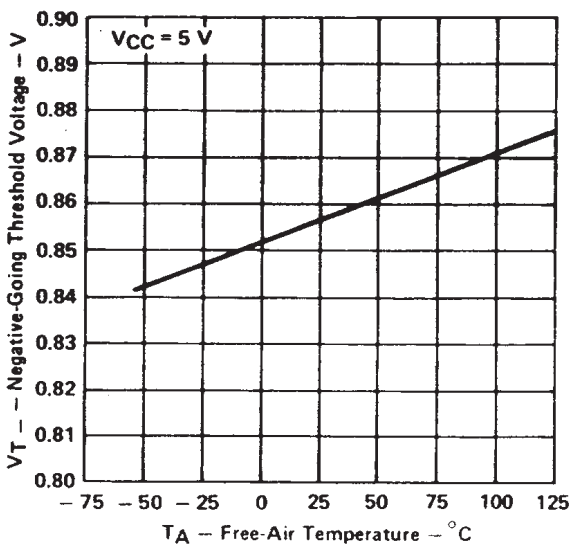
FIGURE 1

TYPICAL CHARACTERISTICS OF '132 CIRCUITS

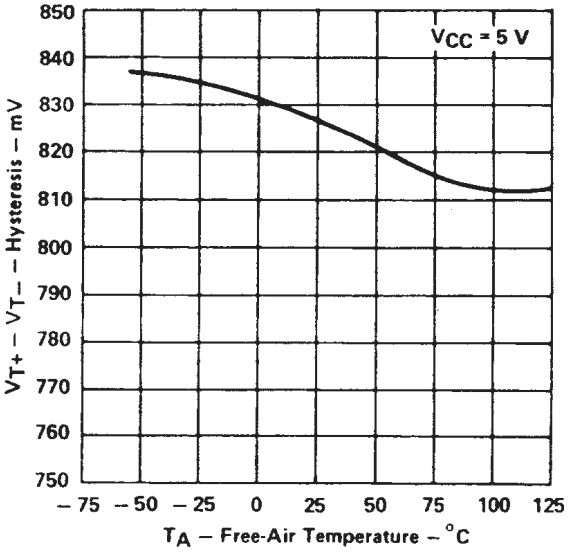
POSITIVE-GOING THRESHOLD VOLTAGE
vs
FREE-AIR TEMPERATURE



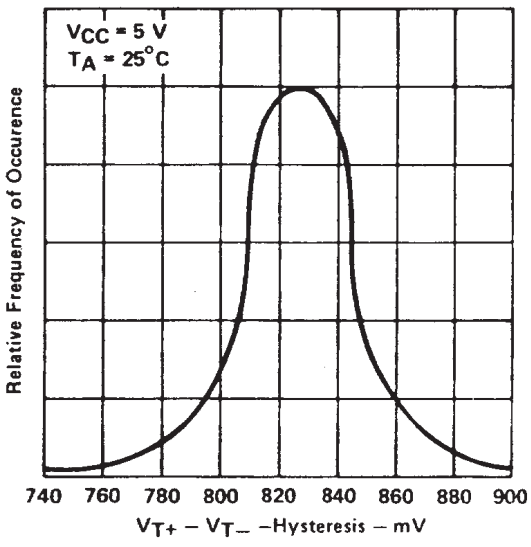
NEGATIVE-GOING THRESHOLD VOLTAGE
vs
FREE-AIR TEMPERATURE



HYSTERESIS
vs
FREE-AIR TEMPERATURE

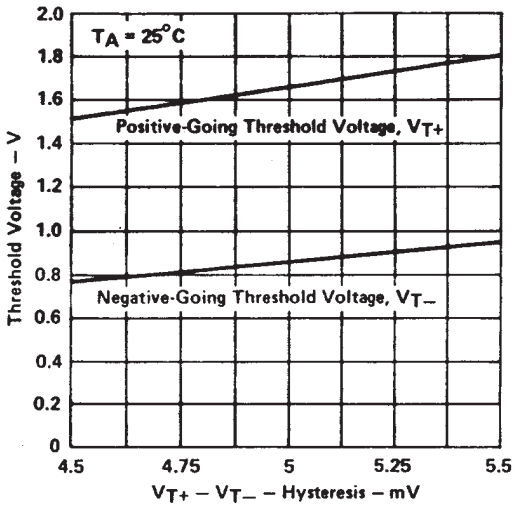


DISTRIBUTION OF UNITS
FOR HYSTERESIS

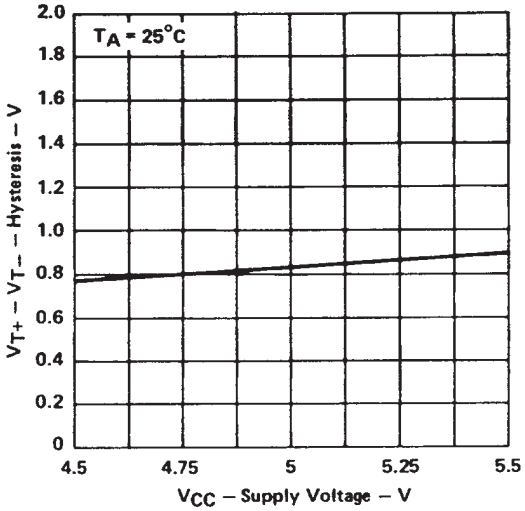


TYPICAL CHARACTERISTICS OF '132 CIRCUITS

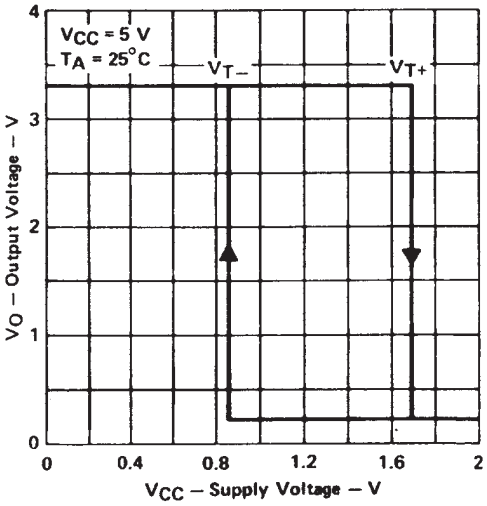
THRESHOLD VOLTAGES
vs
SUPPLY VOLTAGE



HYSTERESIS
vs
SUPPLY VOLTAGE



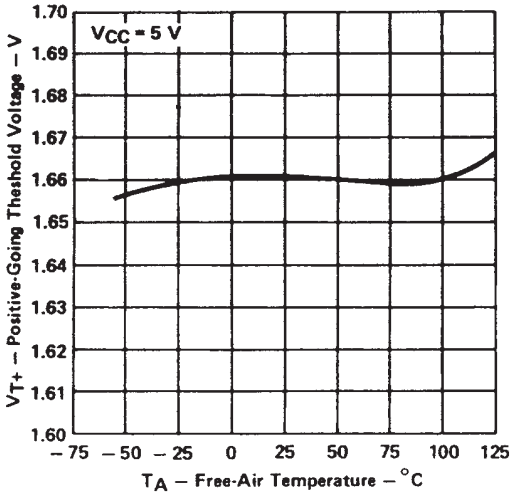
OUTPUT VOLTAGE
vs
INPUT VOLTAGE



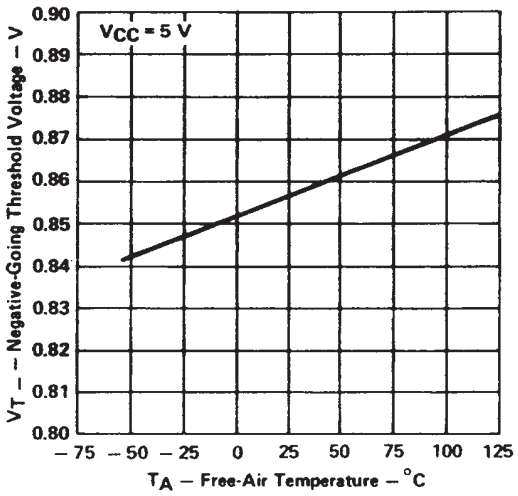
† Data for temperatures below 0°C and 70°C and supply below 4.75 V and above 5.25 V are applicable for SN54132 only.

TYPICAL CHARACTERISTICS OF 'LS132 CIRCUITS

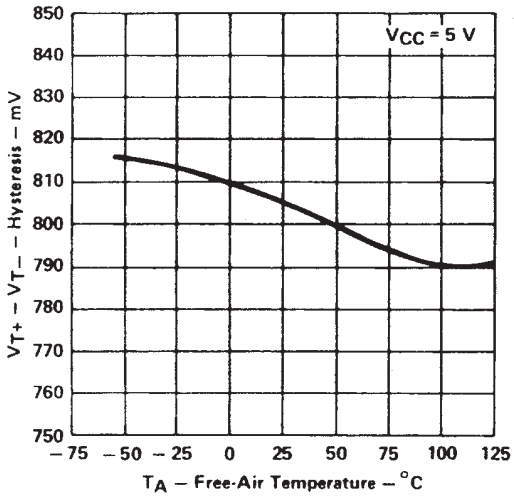
POSITIVE-GOING THRESHOLD VOLTAGE
vs
FREE-AIR TEMPERATURE



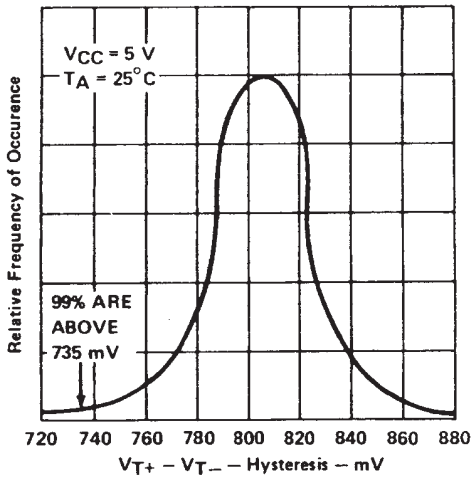
NEGATIVE-GOING THRESHOLD VOLTAGE
vs
FREE-AIR TEMPERATURE



HYSTERESIS
vs
FREE-AIR TEMPERATURE



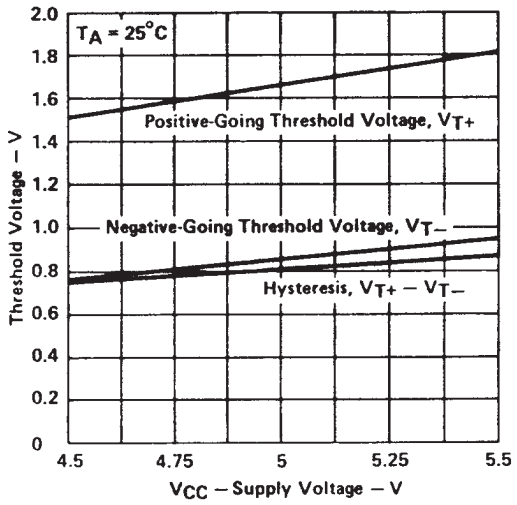
DISTRIBUTION OF UNITS
FOR HYSTERESIS



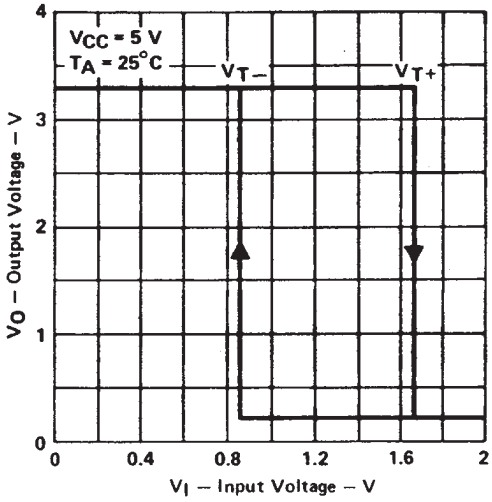
Data for temperatures below 0°C and above 70°C and supply voltages below 4.75 V and above 5.25 V are applicable for SN54LS132 only.

TYPICAL CHARACTERISTICS OF 'LS132 CIRCUITS

THRESHOLD VOLTAGES AND HYSTERESIS
vs
SUPPLY VOLTAGE

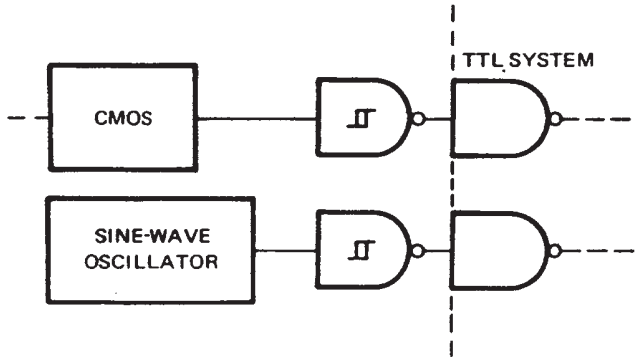


OUTPUT VOLTAGE
vs
INPUT VOLTAGE

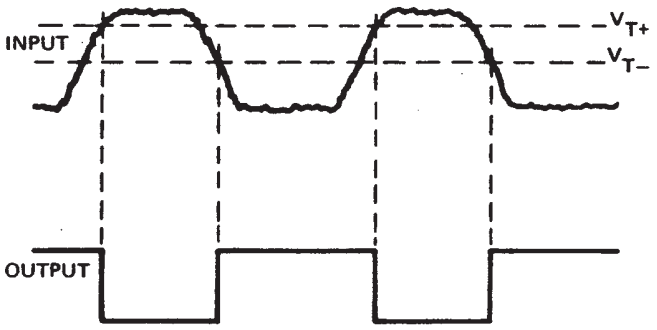


† Data for temperatures below 0°C and above 70°C and supply voltages below 4.75 V and above 5.25 V are applicable for SN54LS132 only.

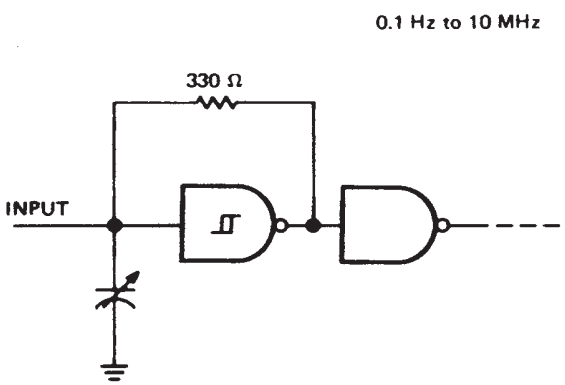
TYPICAL APPLICATION DATA



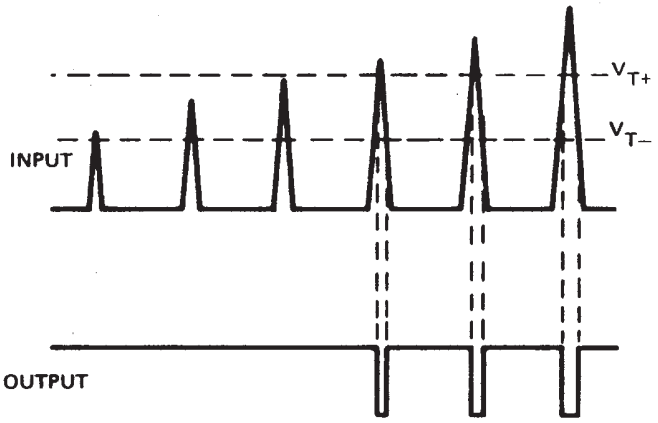
TTL SYSTEM INTERFACE
FOR SLOW INPUT WAVEFORMS



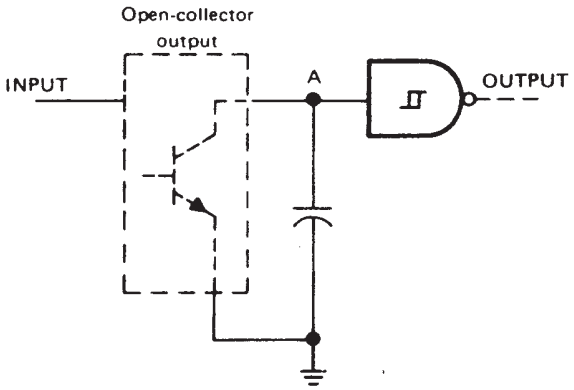
PULSE SHAPER

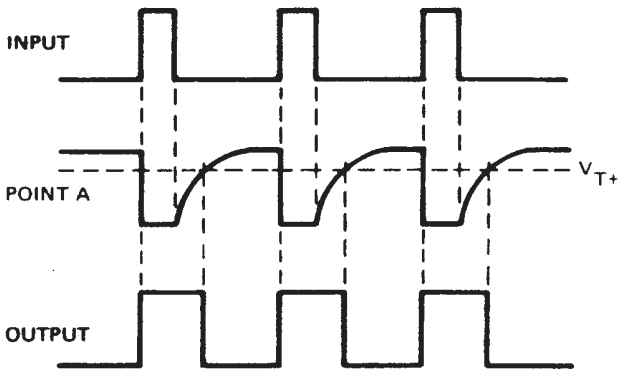


MULTIVIBRATOR



THRESHOLD DETECTOR





PULSE STRETCHER

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
7600401CA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7600401CA SNJ54LS132J	Samples
7600401DA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7600401DA SNJ54LS132W	Samples
7600401DA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7600401DA SNJ54LS132W	Samples
JM38510/31303BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31303BCA	Samples
JM38510/31303BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31303BCA	Samples
M38510/31303BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31303BCA	Samples
M38510/31303BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31303BCA	Samples
SN54LS132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS132J	Samples
SN54LS132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS132J	Samples
SN54S132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54S132J	Samples
SN54S132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54S132J	Samples
SN74LS132D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS132	Samples
SN74LS132D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS132	Samples
SN74LS132DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS132	Samples
SN74LS132DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS132	Samples
SN74LS132N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS132N	Samples
SN74LS132N	ACTIVE	PDIP	N	14	25	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS132N	Samples
SN74LS132NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS132	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS132NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS132	Samples
SNJ54LS132FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 132FK	Samples
SNJ54LS132FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 132FK	Samples
SNJ54LS132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7600401CA SNJ54LS132J	Samples
SNJ54LS132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7600401CA SNJ54LS132J	Samples
SNJ54LS132W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7600401DA SNJ54LS132W	Samples
SNJ54LS132W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7600401DA SNJ54LS132W	Samples
SNJ54S132FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54S 132FK	Samples
SNJ54S132FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54S 132FK	Samples
SNJ54S132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S132J	Samples
SNJ54S132J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S132J	Samples
SNJ54S132W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S132W	Samples
SNJ54S132W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S132W	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

OTHER QUALIFIED VERSIONS OF SN54LS132, SN74LS132 :

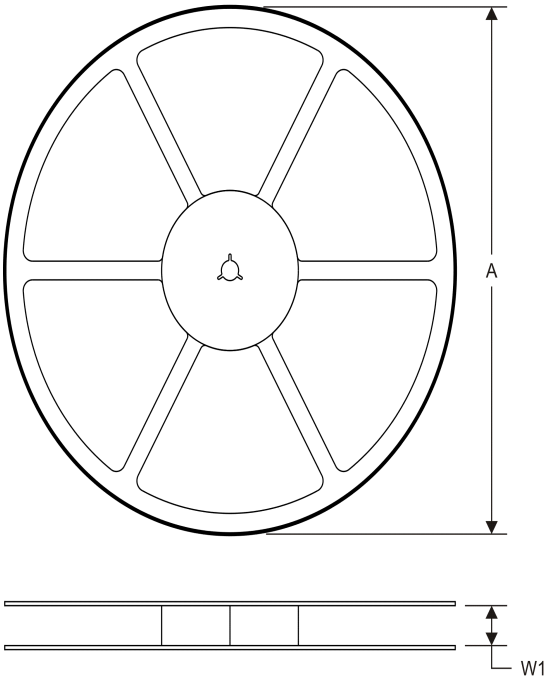
- Catalog: SN74LS132
- Military: SN54LS132

NOTE: Qualified Version Definitions:

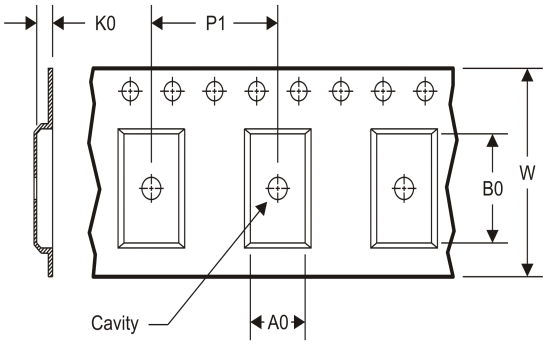
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



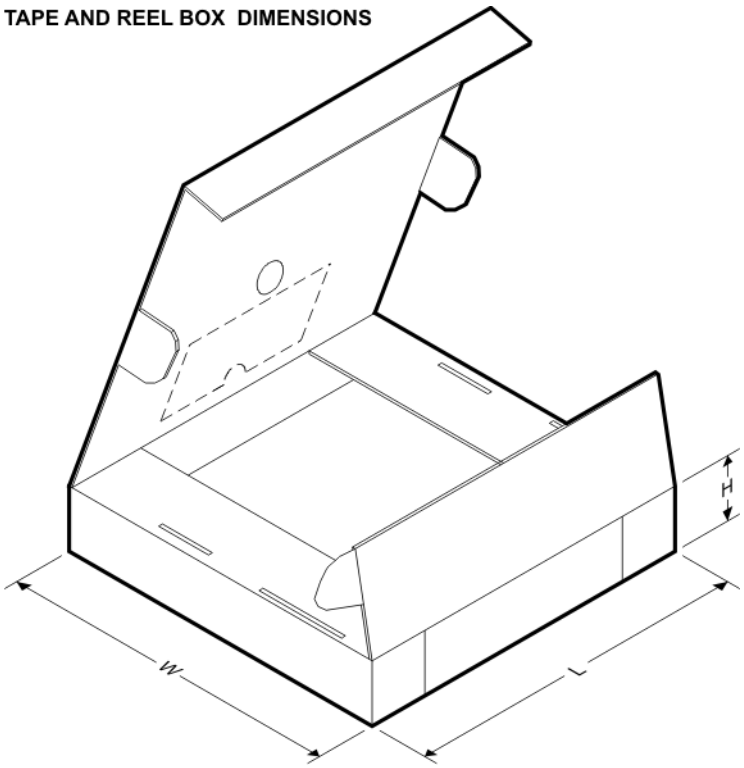
A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS132DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS132NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS

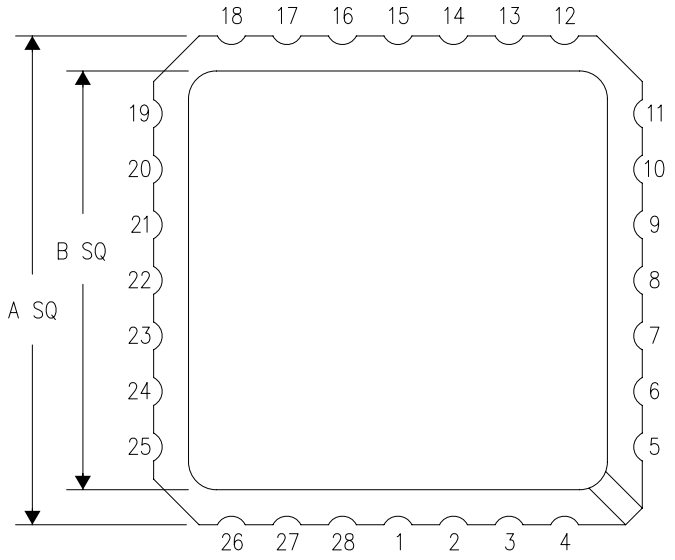


*All dimensions are nominal

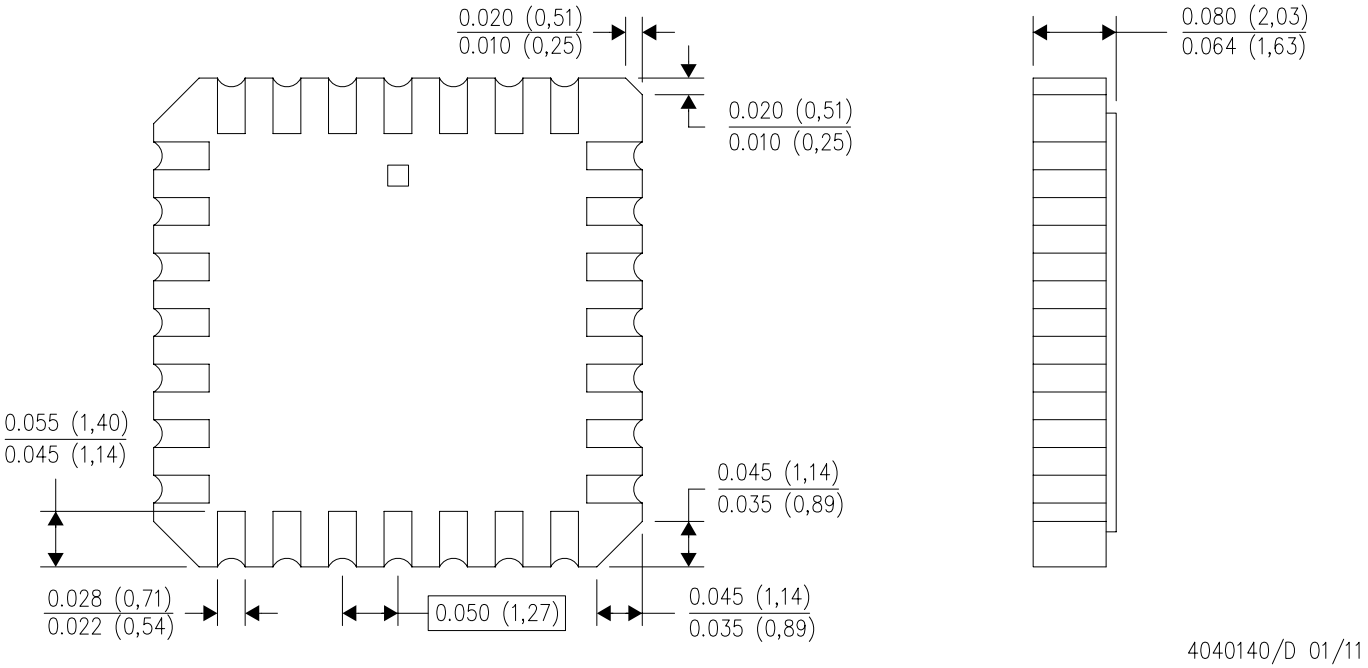
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS132DR	SOIC	D	14	2500	367.0	367.0	38.0
SN74LS132NSR	SO	NS	14	2000	367.0	367.0	38.0

FK (S–CQCC–N**) LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



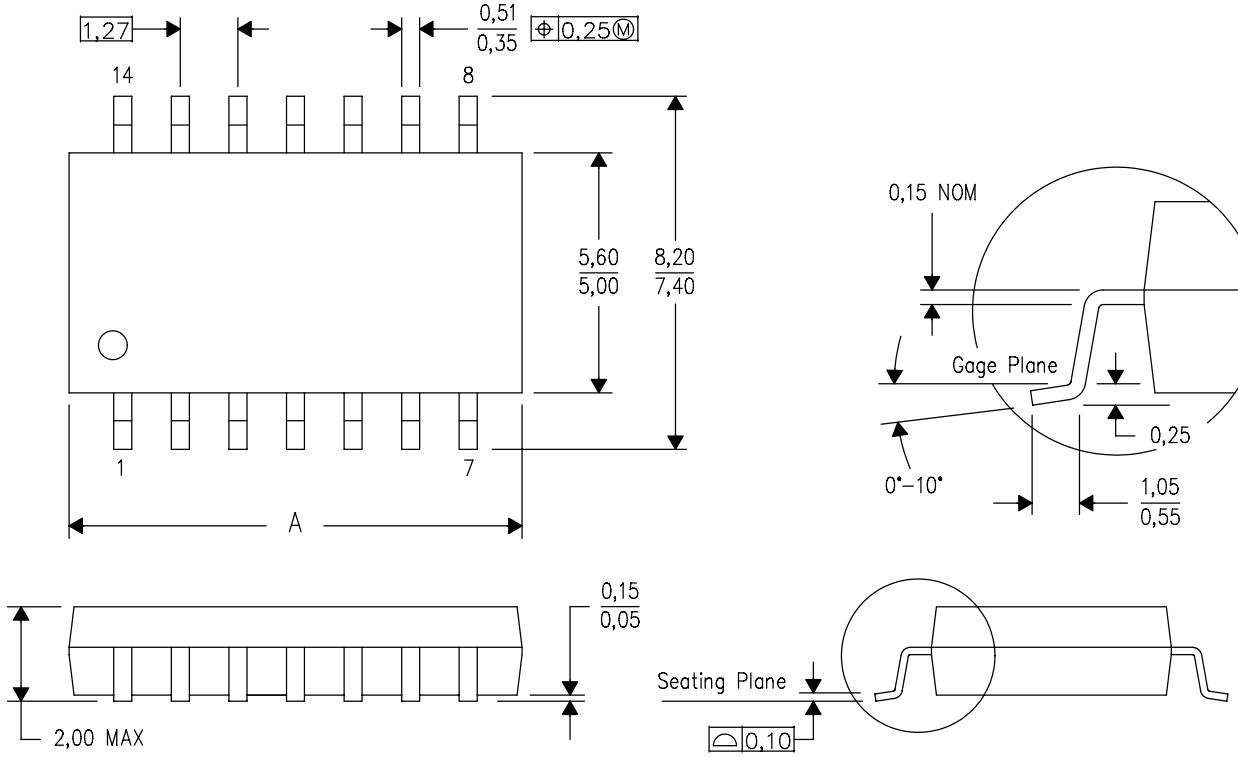
4040140/D 01/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. Falls within JEDEC MS–004

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN

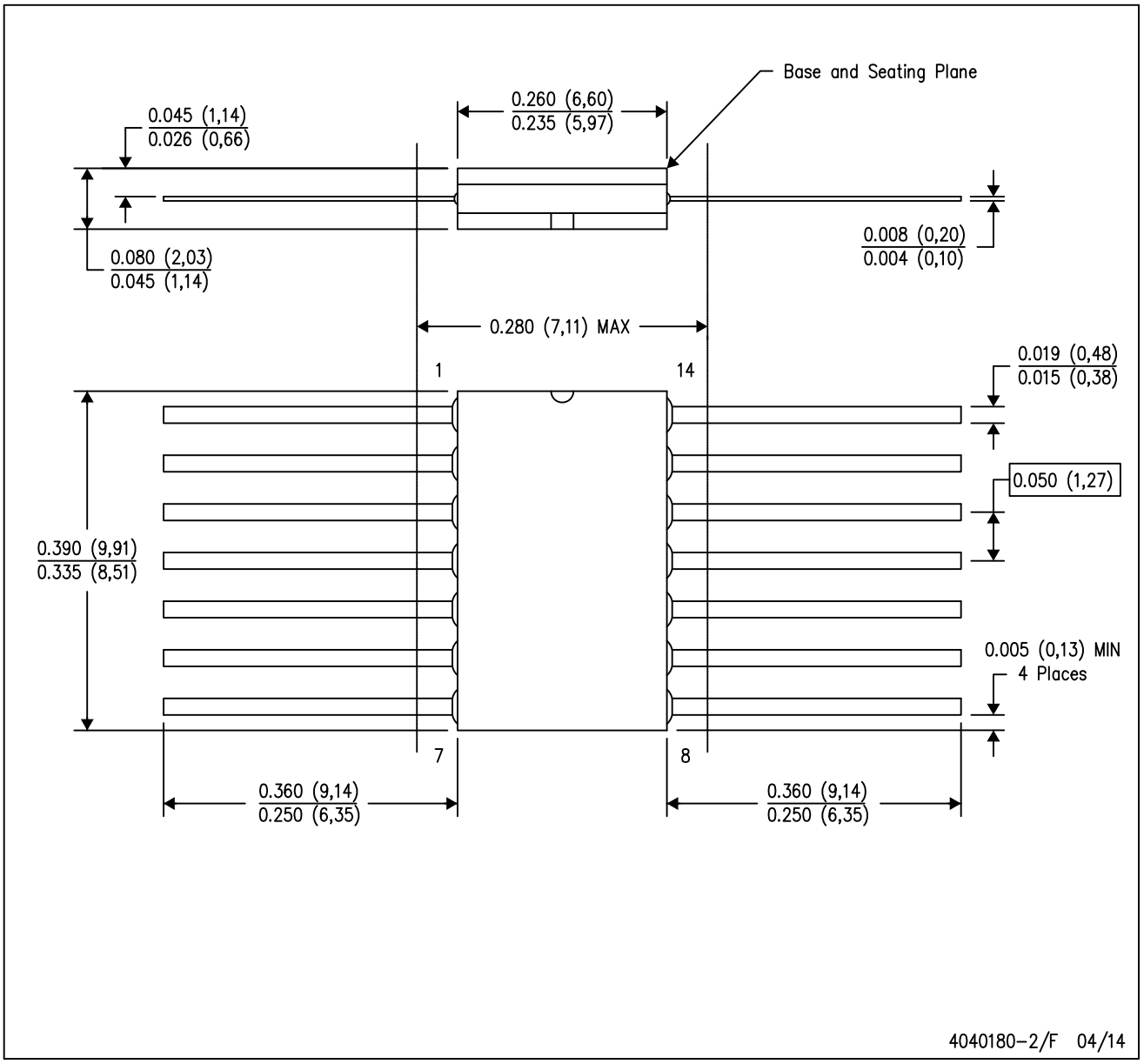


DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

W (R–GDFP–F14) CERAMIC DUAL FLATPACK

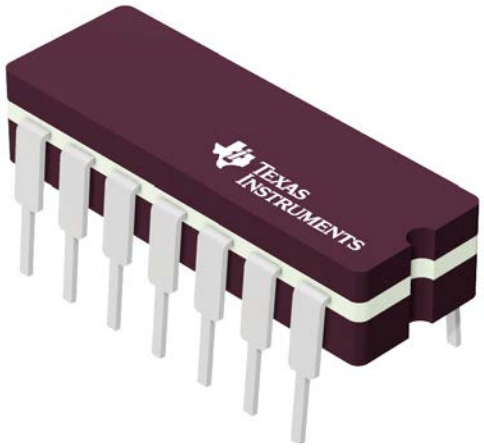


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F14

GENERIC PACKAGE VIEW

J 14 CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

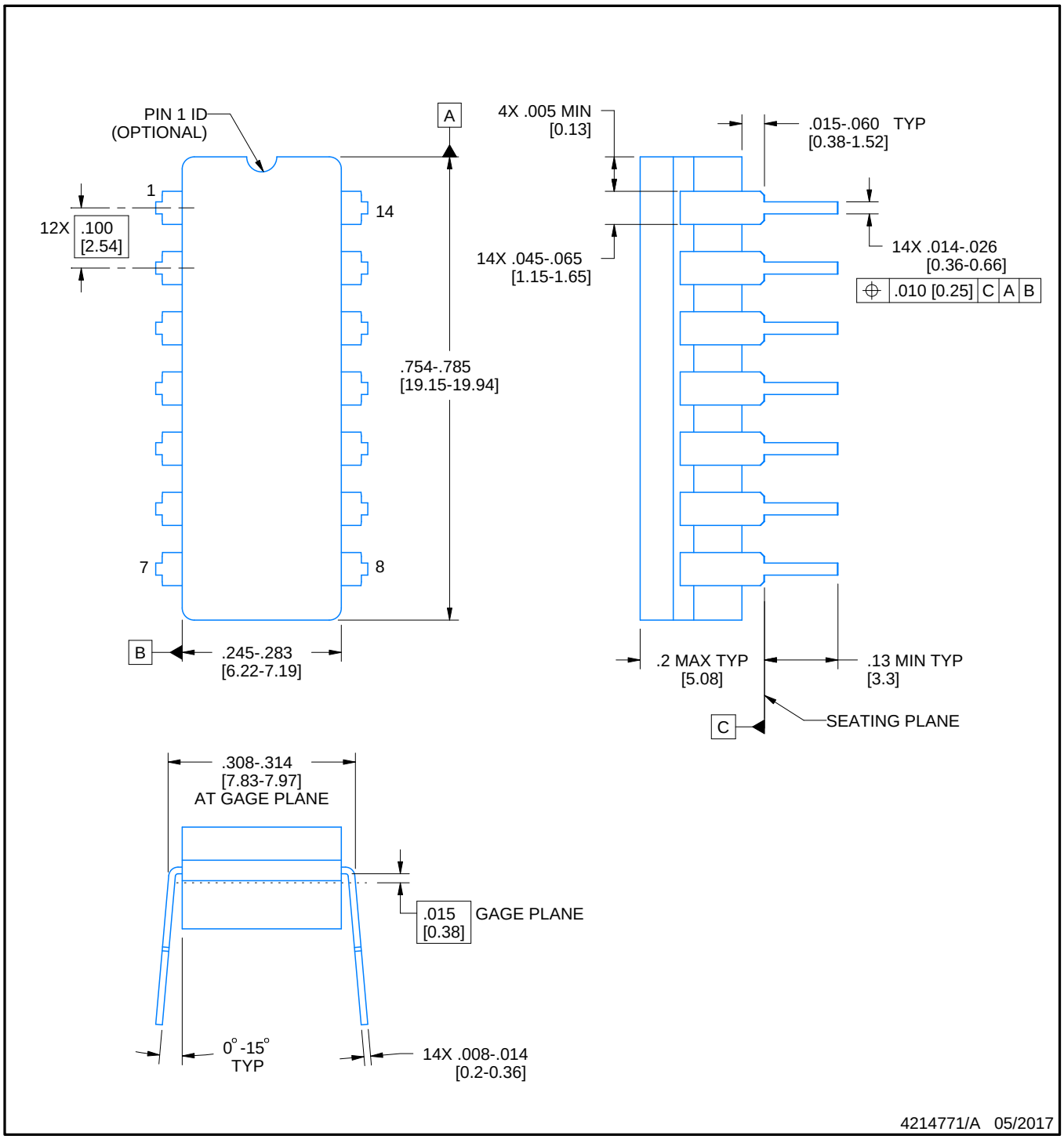
4040083-5/G

PACKAGE OUTLINE

J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

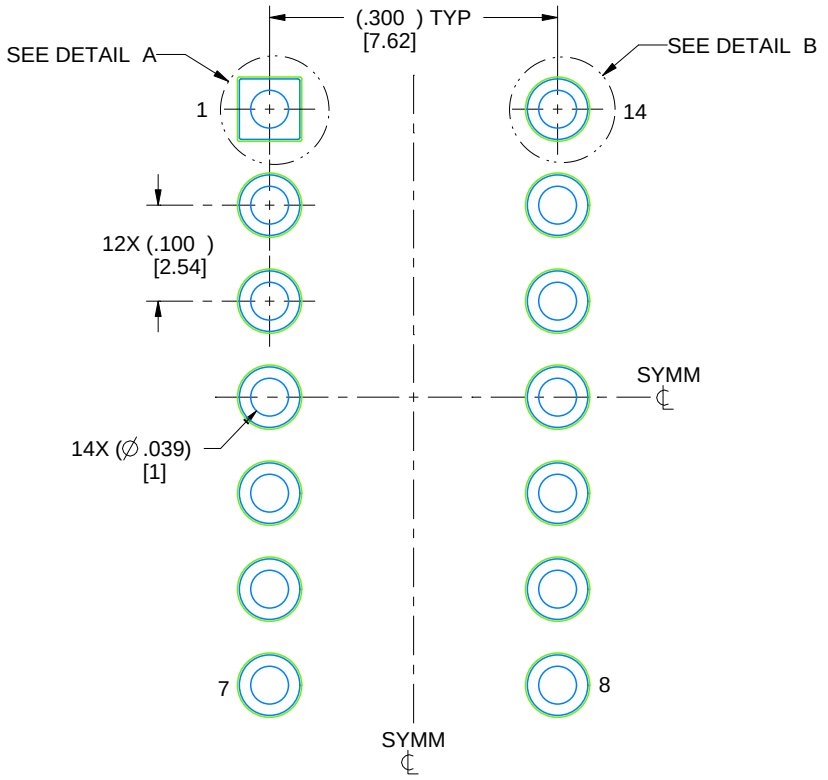
1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermitically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

EXAMPLE BOARD LAYOUT

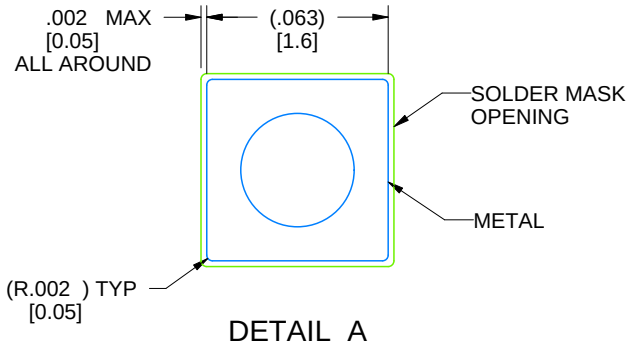
J0014A

CDIP - 5.08 mm max height

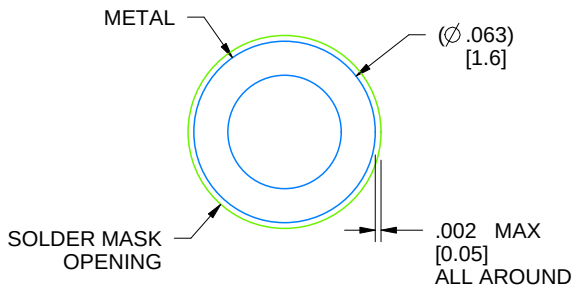
CERAMIC DUAL IN LINE PACKAGE



LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE: 5X



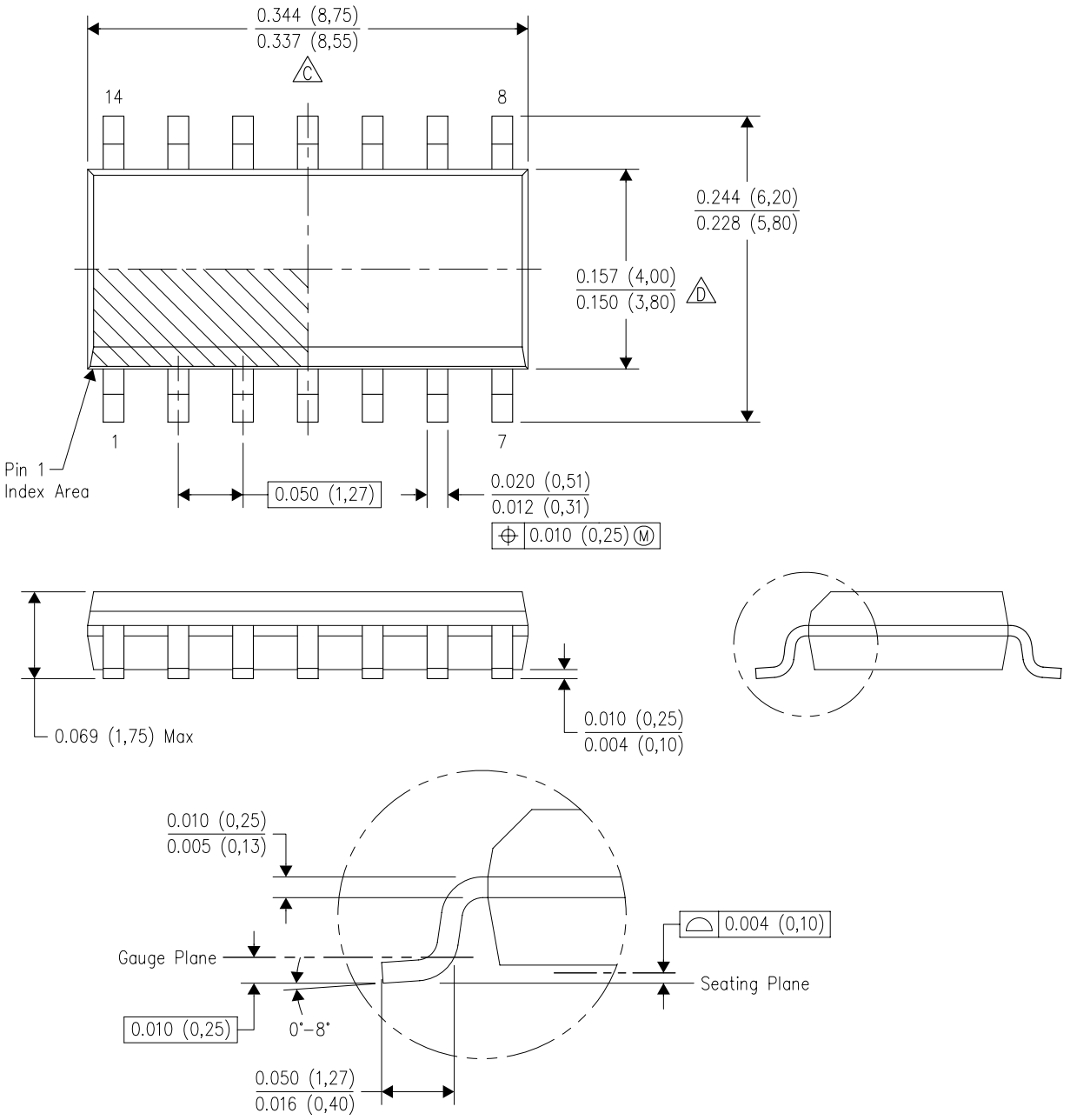
DETAIL A
SCALE: 15X



DETAIL B
13X, SCALE: 15X

4214771/A 05/2017

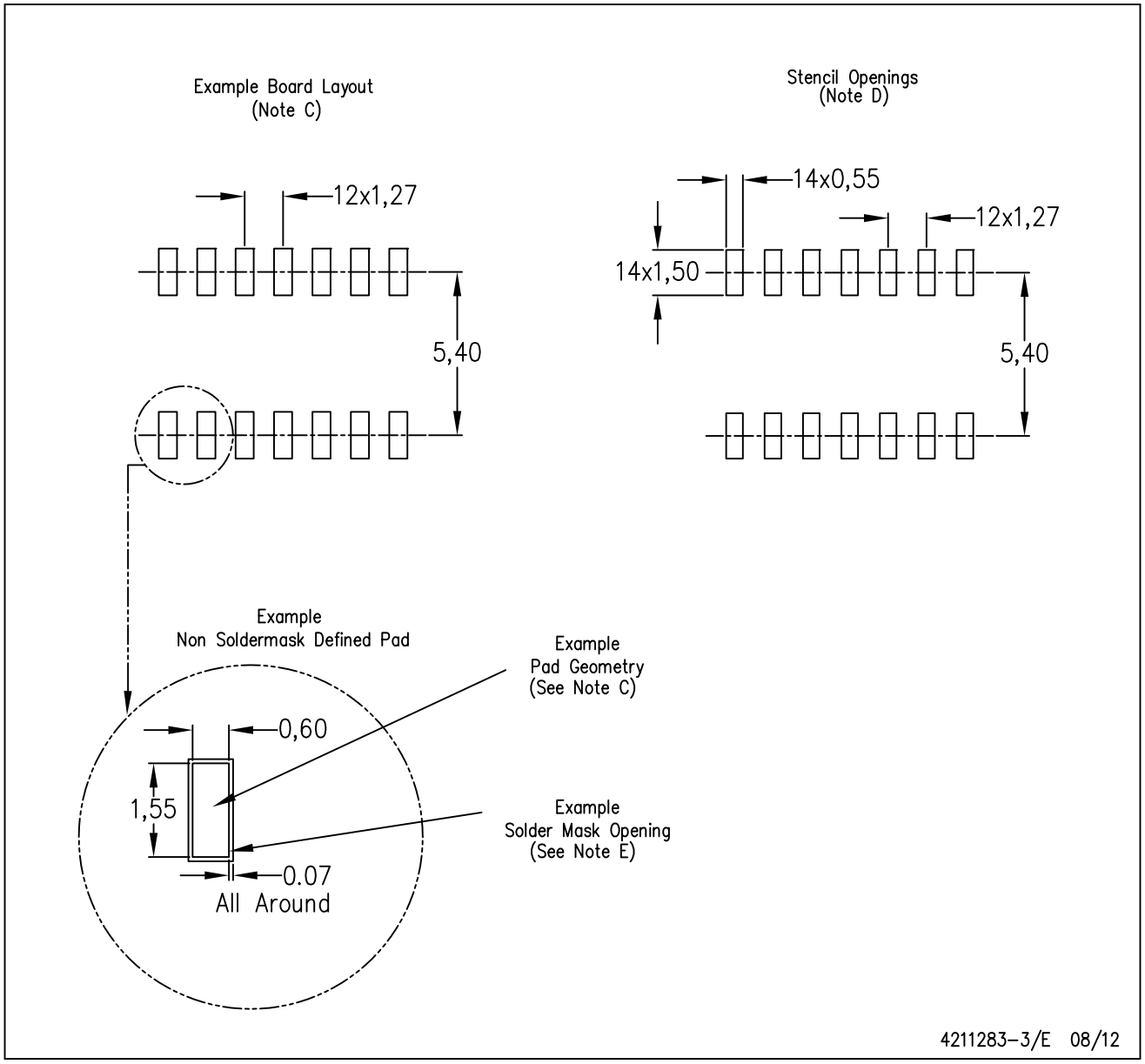
D (R–PDSO–G14) PLASTIC SMALL OUTLINE



4040047–5/M 06/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AB.

D (R–PDSO–G14) PLASTIC SMALL OUTLINE

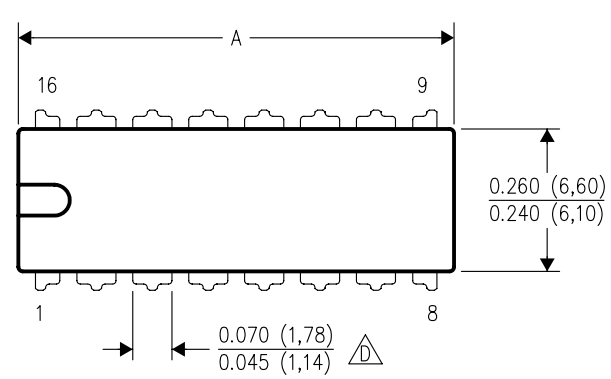


NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC–7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC–7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

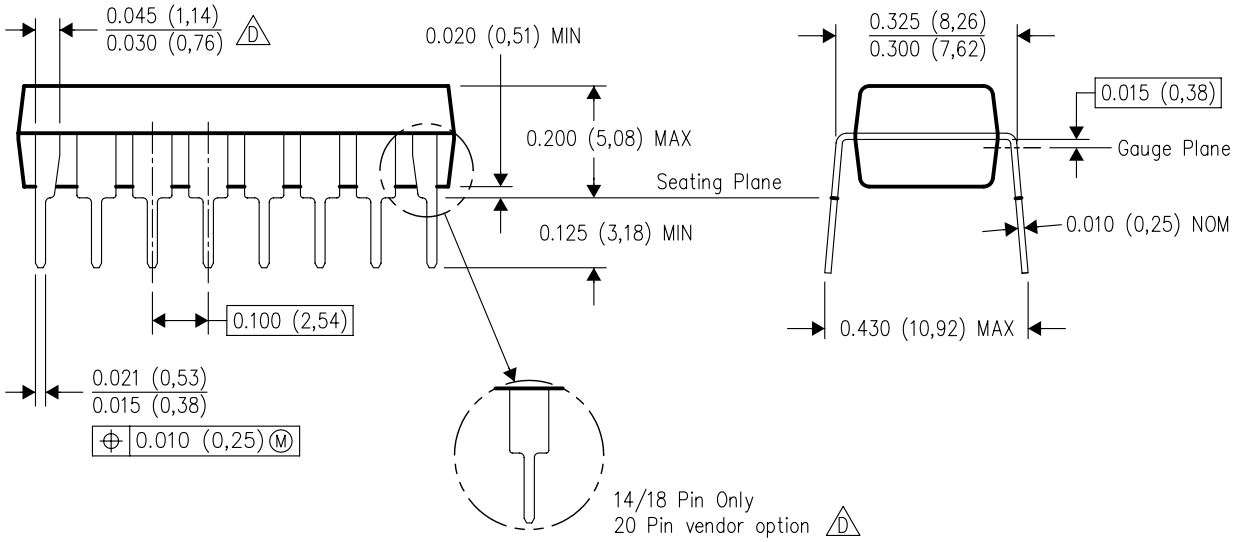
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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